



# Electronics Team

## Design Challenge 1 Specification

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*Revision A*

*Last Revised on 4/4/2020*

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# Overview

*This board will be taking the data read from a potentiometer and sending its data over the CAN bus.*

## Special System Considerations

- *This board MUST use an external ADC from the microcontroller.*
- *The potentiometer will be connected to the board via a 4-pin microfit connector.*
- *The standard stacking header will be used*
- *The required Microcontorller is the STM 32 pin*

## Electrical

### Electrical Specifications

	Min	Typical	Max	Units
Input Voltage	See micro spec	3.3	See micro spec	V
Output Voltage				V
MCU Voltage	See micro spec	3.3	See micro spec	V
Expected Current				A
Power Consumed				W

## Mechanical

### Board Size, Clearances, and Edge Features

	Min	Max	Units
Width	2000	-	mil
Length	3000	-	mil

Vertical Clearance			mil
Edge Clearance			mil

## Mounting Features

Use the standard mounting holes

## Communications

### Communications Protocol

CAN over the stacking header

### Packet IDs & Definitions

## Budget

	Budget	Units
Parts	-	\$
Manufacturing	-	\$
Tools & Specialized Equipment	-	\$
<i>Maximum Allowable Budget:</i>	<b>N/A</b>	<b>\$</b>

## Timeline

### Electronics Deadlines

Task	Deadline
Block Diagram	N/A

Rough Schematic	N/A
Draft Schematic	4/7/2020
Schematic Review	4/7/2020
Rough Board Layup	N/A
Draft Board Layup	4/9/2020
Board Review	4/9/2020
Final BOM	4/9/2020
Final GERBERS	N/A
Board Ordered	N/A